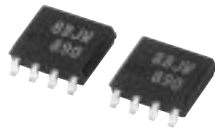


FY8ABJ-03

HIGH-SPEED SWITCHING USE

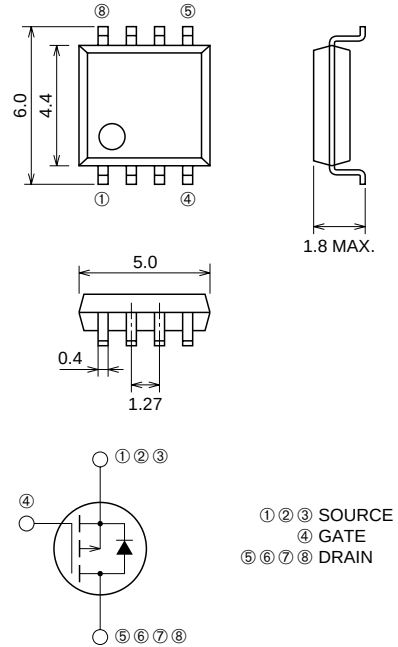
FY8ABJ-03



- 4V DRIVE
- V_{DS} -30V
- $r_{DS(ON)}$ (MAX) 20m Ω
- I_D -8A

OUTLINE DRAWING

Dimensions in mm



SOP-8

APPLICATION

Motor control, Lamp control, Solenoid control
DC-DC converter, etc.

MAXIMUM RATINGS (T_c = 25°C)

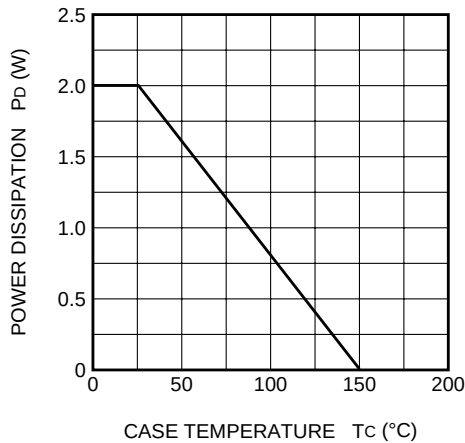
Symbol	Parameter	Conditions	Ratings	Unit
V_{DS}	Drain-source voltage	$V_{GS} = 0V$	-30	V
V_{GSS}	Gate-source voltage	$V_{DS} = 0V$	± 20	V
I_D	Drain current		-8	A
I_{DM}	Drain current (Pulsed)		-56	A
I_{DA}	Avalanche drain current (Pulsed)	$L = 10\mu H$	-8	A
I_S	Source current		-2.1	A
I_{SM}	Source current (Pulsed)		-8.4	A
P_D	Maximum power dissipation		2.0	W
T_{ch}	Channel temperature		-55 ~ +150	°C
T_{stg}	Storage temperature		-55 ~ +150	°C
—	Weight	Typical value	0.07	g

ELECTRICAL CHARACTERISTICS (Tch = 25°C)

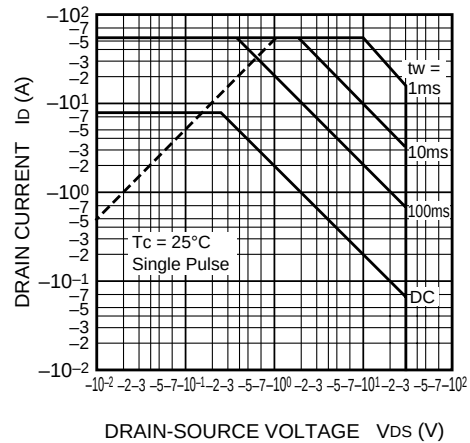
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	Id = -1mA, VGS = 0V	-30	—	—	V
IGSS	Gate-source leakage current	VGS = ±20V, VDS = 0V	—	—	±0.1	μA
IDSS	Drain-source leakage current	VDS = -30V, VGS = 0V	—	—	-0.1	mA
VGS(th)	Gate-source threshold voltage	Id = -1mA, VDS = -10V	-1.5	-2.0	-2.5	V
rDS(ON)	Drain-source on-state resistance	Id = -8A, VGS = -10V	—	14	20	mΩ
rDS(ON)	Drain-source on-state resistance	Id = -4A, VGS = -4V	—	26	37	mΩ
VDS(ON)	Drain-source on-state voltage	Id = -8A, VGS = -10V	—	0.112	0.160	V
yfs	Forward transfer admittance	Id = -8A, VDS = -10V	—	19	—	S
Ciss	Input capacitance	VDS = -10V, VGS = 0V, f = 1MHz	—	3650	—	pF
Coss	Output capacitance		—	900	—	pF
Crss	Reverse transfer capacitance		—	385	—	pF
td(on)	Turn-on delay time	VDD = -15V, Id = -4A, VGS = -10V, RGEN = RGS = 50Ω	—	30	—	ns
tr	Rise time		—	55	—	ns
td(off)	Turn-off delay time		—	250	—	ns
tf	Fall time		—	105	—	ns
VSD	Source-drain voltage	IS = -2.1A, VGS = 0V	—	-0.77	-1.20	V
Rth(ch-a)	Thermal resistance	Channel to ambient	—	—	62.5	°C/W
trr	Reverse recovery time	IS = -2.1A, dis/dt = 50A/μs	—	100	—	ns

PERFORMANCE CURVES

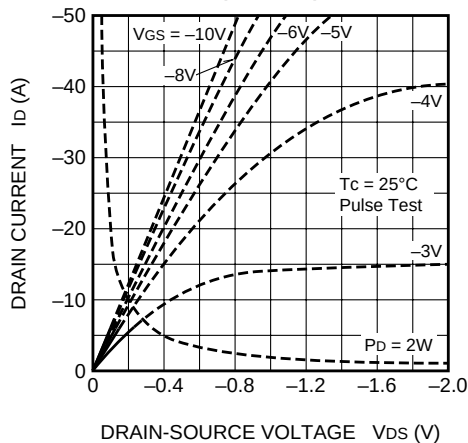
POWER DISSIPATION DERATING CURVE



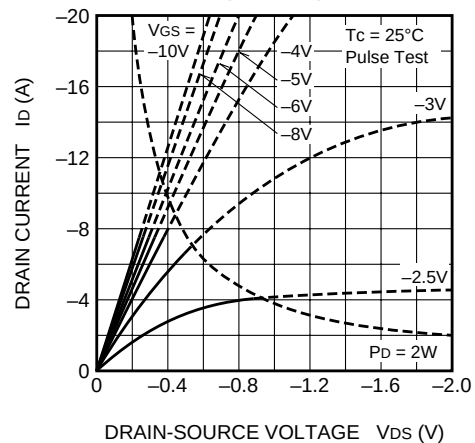
MAXIMUM SAFE OPERATING AREA

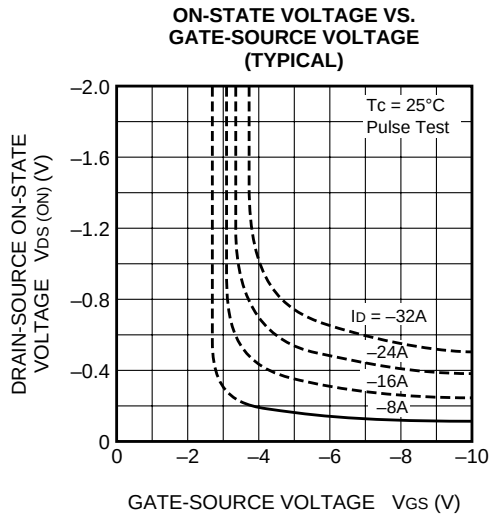
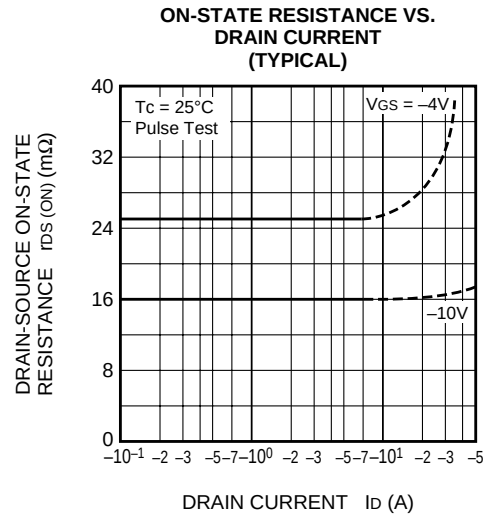
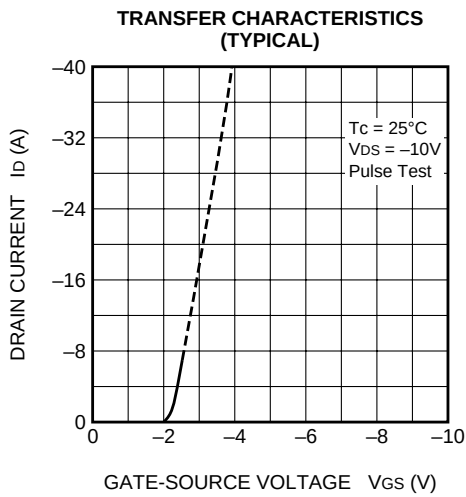
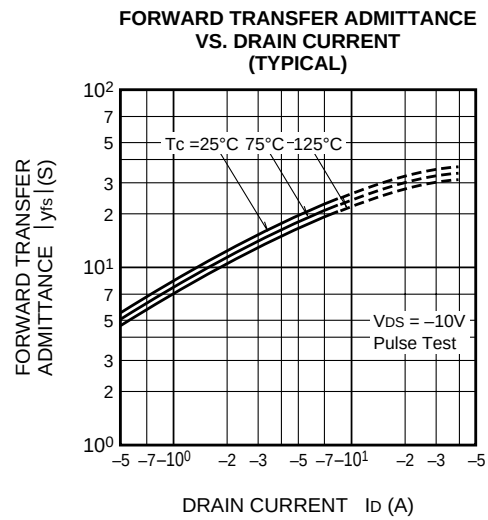
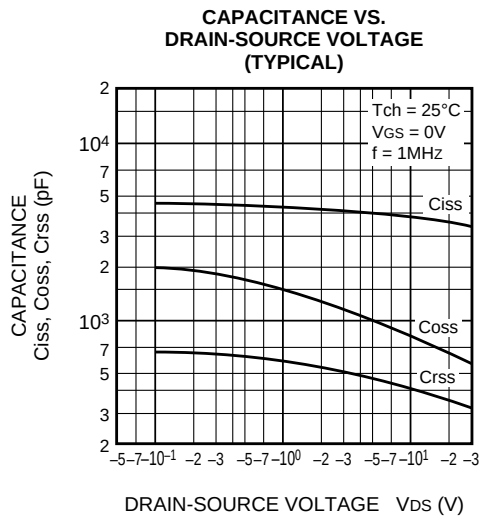
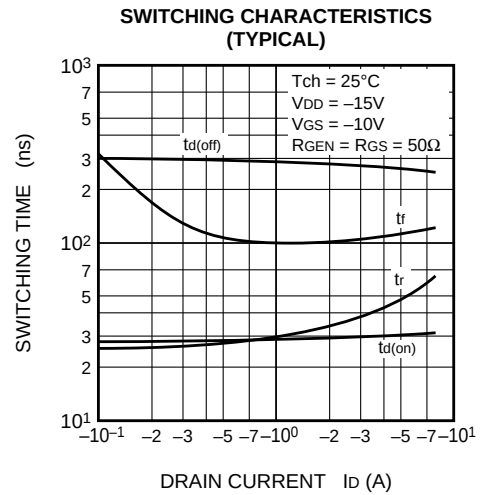


OUTPUT CHARACTERISTICS (TYPICAL)

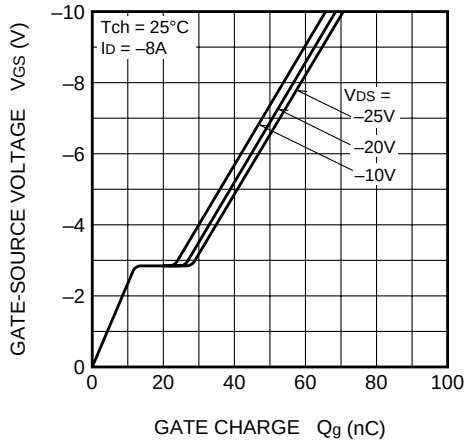


OUTPUT CHARACTERISTICS (TYPICAL)

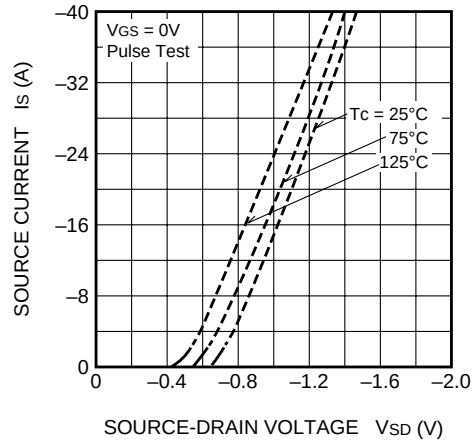




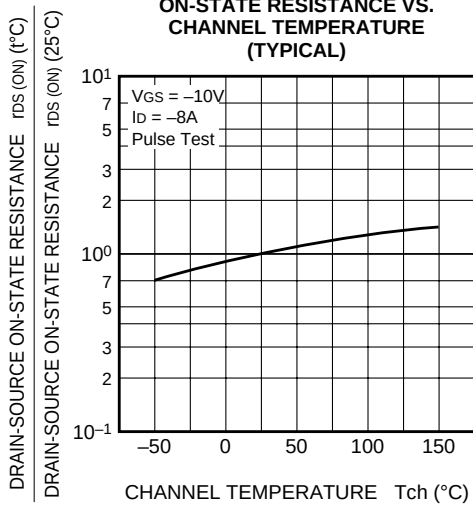
GATE-SOURCE VOLTAGE
VS. GATE CHARGE
(TYPICAL)



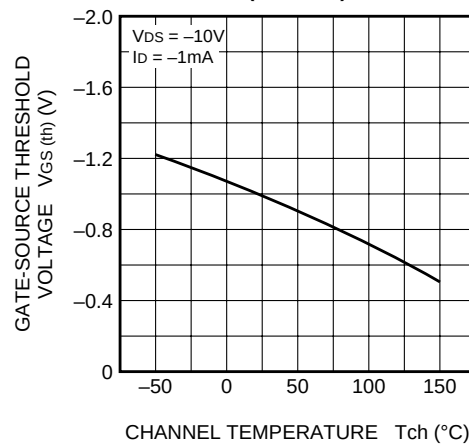
SOURCE-DRAIN DIODE
FORWARD CHARACTERISTICS
(TYPICAL)



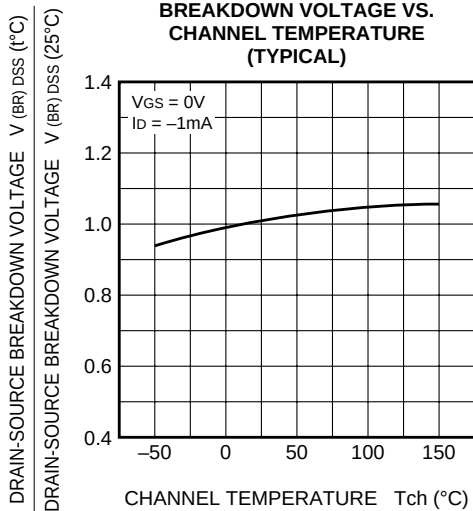
ON-STATE RESISTANCE VS.
CHANNEL TEMPERATURE
(TYPICAL)



THRESHOLD VOLTAGE VS.
CHANNEL TEMPERATURE
(TYPICAL)



BREAKDOWN VOLTAGE VS.
CHANNEL TEMPERATURE
(TYPICAL)



TRANSIENT THERMAL IMPEDANCE
CHARACTERISTICS

